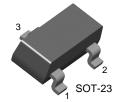


# MMBT2907AK

# **PNP Epitaxial Silicon Transistor**

## **General Purpose Transistor**





1. Base 2. Emitter 3. Collector

## Absolute Maximum Ratings T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	-60	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-60	V
$V_{EBO}$	Emitter-Base Voltage	-5	V
I <sub>C</sub>	Collector Current	-600	mA
P <sub>C</sub>	Collector Power Dissipation	350	mW
T <sub>STG</sub>	Storage Temperature	150	°C

## **Electrical Characteristics** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-60		V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage *	I <sub>C</sub> = -10mA, I <sub>B</sub> = 0	-60		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5		V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0		-0.01	μΑ
h <sub>FE</sub>	DC Current Gain	$V_{CE} = -10V, I_{C} = -0.1 mA$ $V_{CE} = -10V, I_{C} = -1.0 mA$ $V_{CE} = -10V, I_{C} = -10 mA$ $V_{CE} = -10V, I_{C} = -150 mA *$ $V_{CE} = -10V, I_{C} = -500 mA *$	75 100 100 100 50	300	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage *	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		-0.4 -1.6	V V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage *	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		-1.3 -2.6	V V
f <sub>T</sub>	Current Gain Bandwidth Product	$I_C = -50 \text{mA}, V_{CE} = -20 \text{V}, f = 100 \text{MHz}$	200		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0, f = 1.0MHz		8	pF
t <sub>ON</sub>	Turn On Time	V <sub>CC</sub> = -30V, I <sub>C</sub> = -150mA I <sub>B1</sub> = -15mA		50	ns
t <sub>OFF</sub>	Turn Off Time	$V_{CC} = -6V, I_C = -150 \text{mA}$ 110 $I_{B1} = I_{B2} = -15 \text{mA}$		ns	

<sup>\*</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

## **Typical Performance Characteristics**

Figure 1. DC current Gain

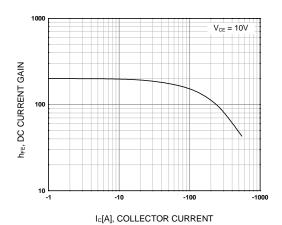
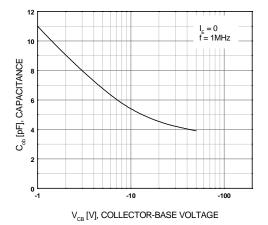


Figure 3. Output Capacitance



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Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

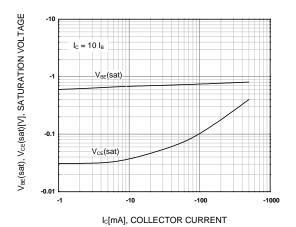
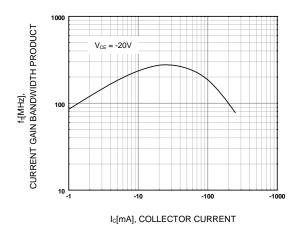


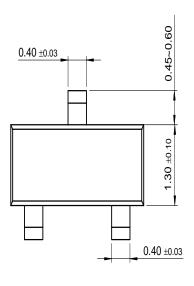
Figure 4. Current Gain Bandwidth Product

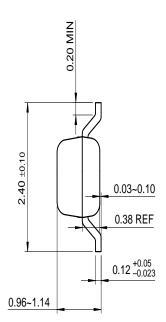


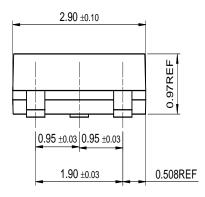
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## **Mechanical Dimensions**

# SOT-23







Dimensions in Millimeters

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